

TLPGE19TP(F),TLFGE19TP(F),TLGE19TP(F),TLPYE19TP(F)

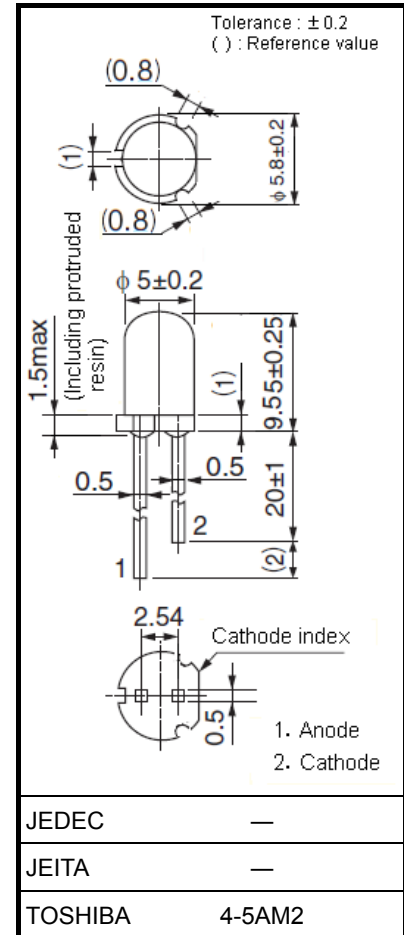
Panel Circuit Indicator

- ϕ 5mm package
 - InGaAlP technology
 - Transparent lens
 - Lineup: 3 colors (pure green, green, pure yellow)
 - High intensity light emission
 - Excellent low current light output
 - Applications: Various types of information panels, backlightings, etc.
 - Stopper lead type is also available
- TLPGE19T(F), TLFGE19T(F), TLGE19T(F), TLPYE19T(F)

Lineup

Product Name	Color	Material
TLPGE19TP(F)	Pure Green	InGaAlP
TLFGE19TP(F)	Green	
TLGE19TP(F)	Green	
TLPYE19TP(F)	Pure Yellow	

Unit: mm



Weight: 0.31 g (typ.)

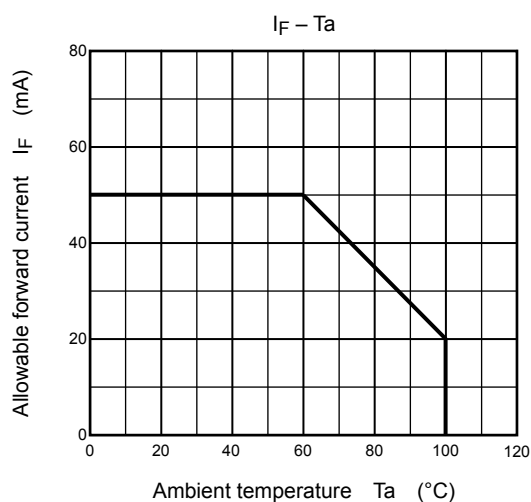
Absolute Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I_F (mA)(Note1)	Reverse Voltage V_R (V)	Power Dissipation P_D (mW)	Operating Temperature T_{opr} (°C)	Storage Temperature T_{stg} (°C)
TLPGE19TP(F)	50	4	120	-40 to 100	-40 to 120
TLFGE19TP(F)	50	4	120		
TLGE19TP(F)	50	4	120		
TLPYE19TP(F)	50	4	120		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Forward current derating



Electrical and Optical Characteristics (Ta = 25°C)

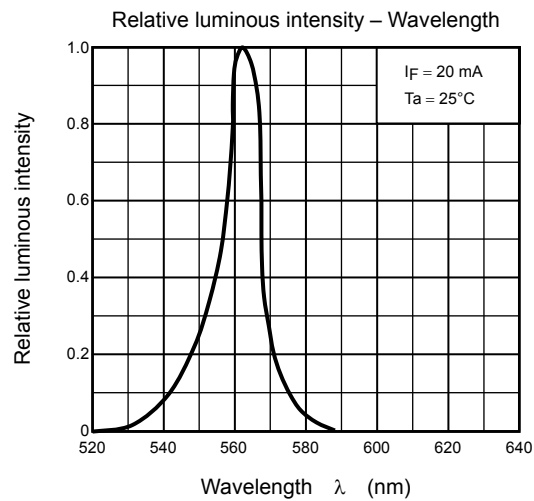
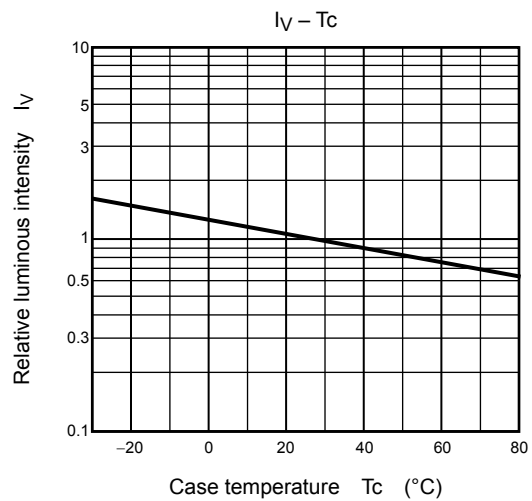
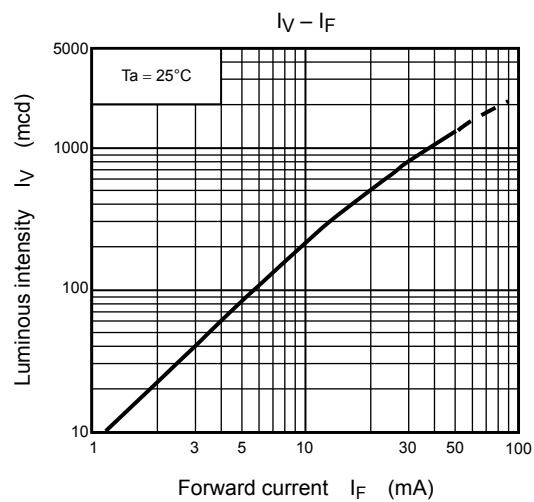
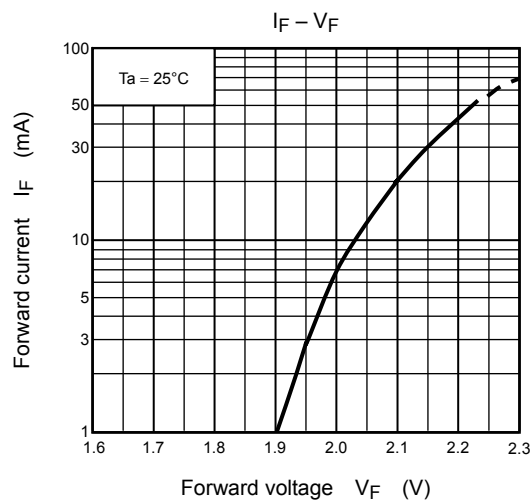
Product Name	Emission Wavelength						Luminous Intensity I _V			Forward Voltage V _F			Reverse Current I _R	
	λ _d			λ _p	Δλ	I _F	Min	Typ.	I _F	Min	Typ.	I _F	Max	I _F
	Min	Typ.	Max	Typ.	Typ.									
TLPGE19TP(F)	—	558	564	562	14	20	153	500	20	2.1	2.4	20	50	4
TLFGE19TP(F)	559	565	570	568	15	20	272	800	20	2.0	2.4	20	50	4
TLGE19TP(F)	565	571	576	574	17	20	476	1300	20	2.0	2.4	20	50	4
TLPYE19TP(F)	574	580	586	583	14	20	476	2000	20	2.0	2.4	20	50	4
Unit	nm					mA	mcd			V			mA	V

Precautions

Please be careful of the following:

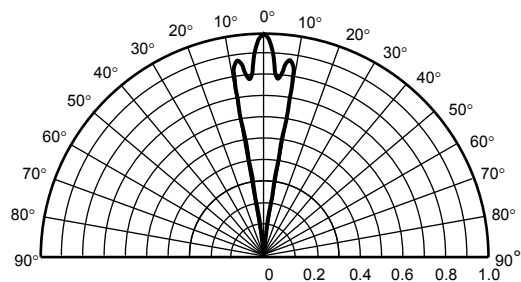
- Soldering temperature: 260°C max, soldering time: 3 s max
(soldering portion of lead: up to 1.6 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light.
If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

TLPGE19TP(F)

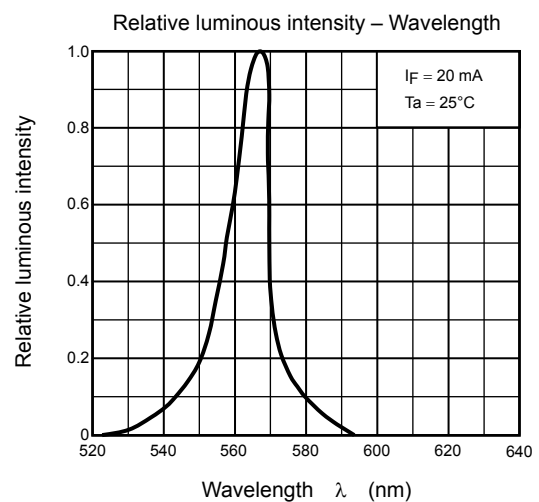
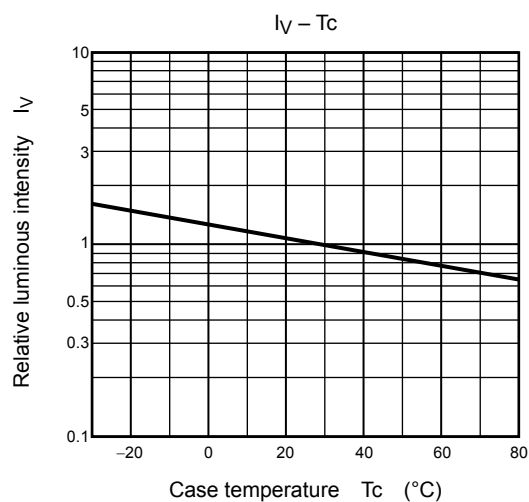
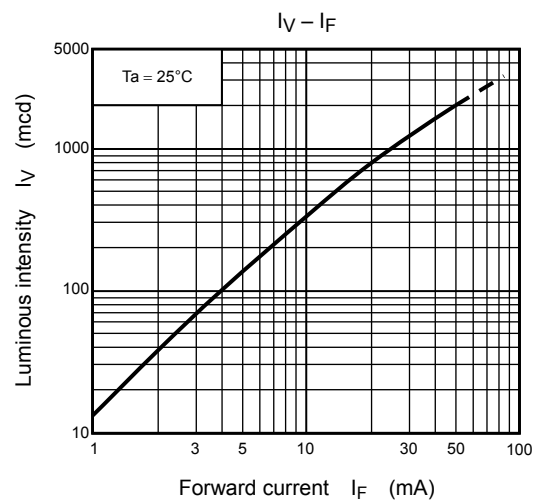
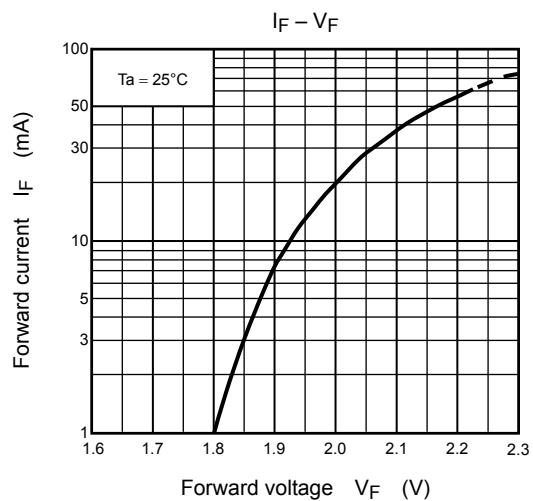


Radiation pattern

Ta = 25°C

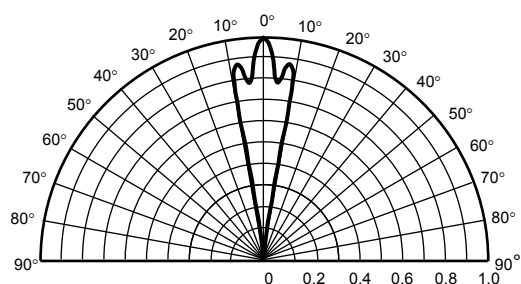


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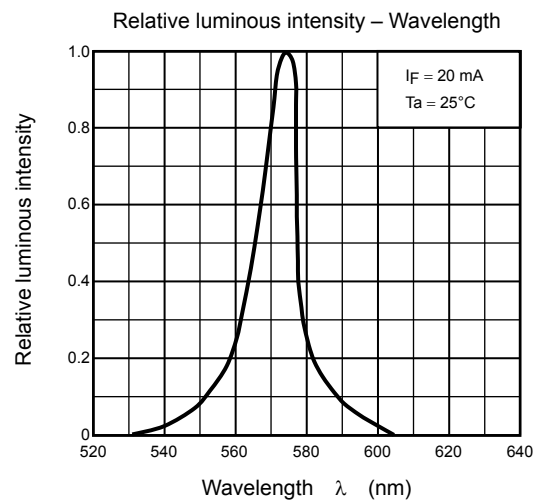
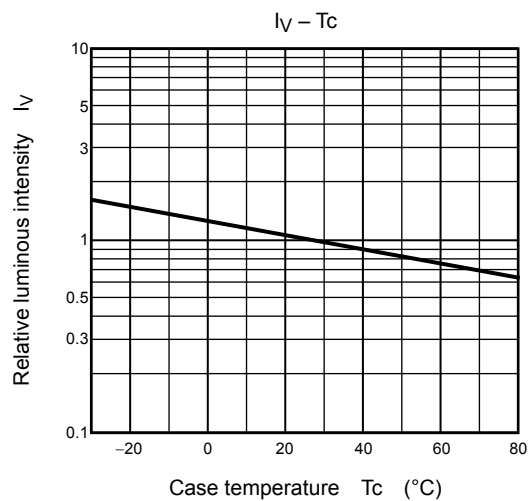
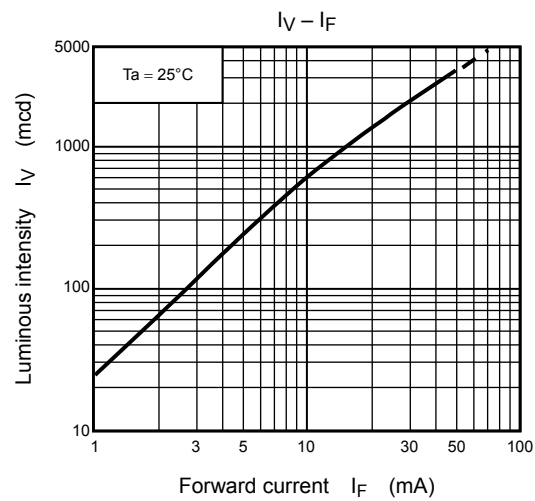
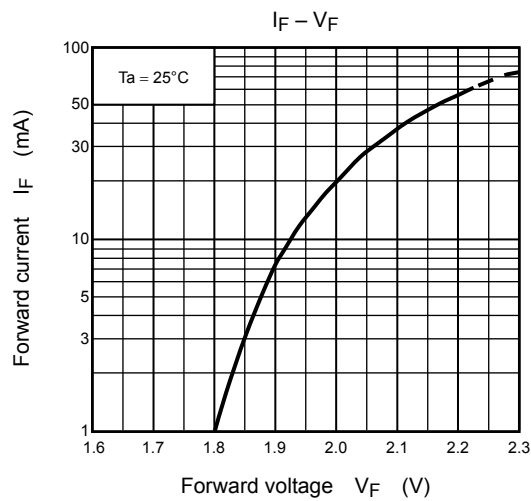


Radiation pattern

$T_a = 25^\circ\text{C}$

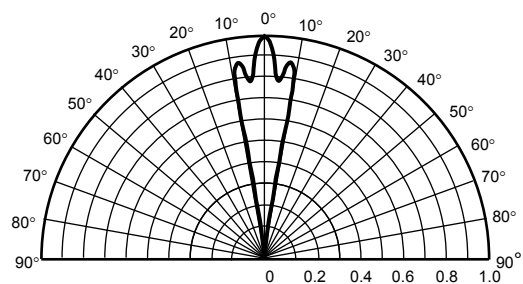


TLGE19TP(F)

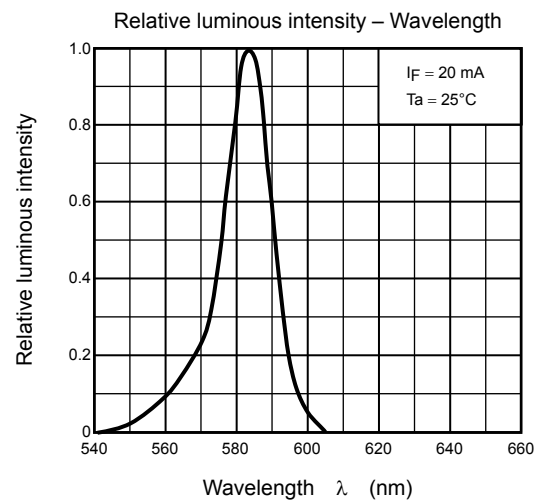
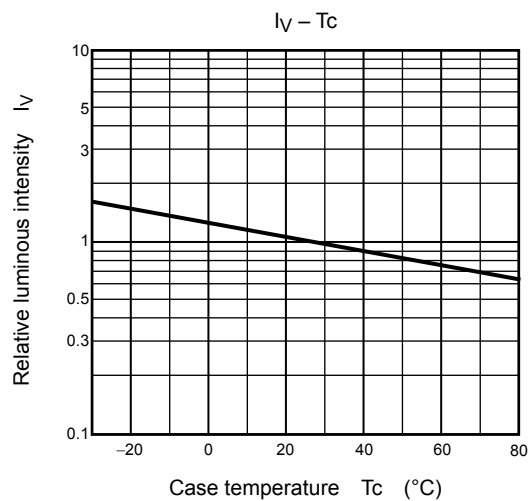
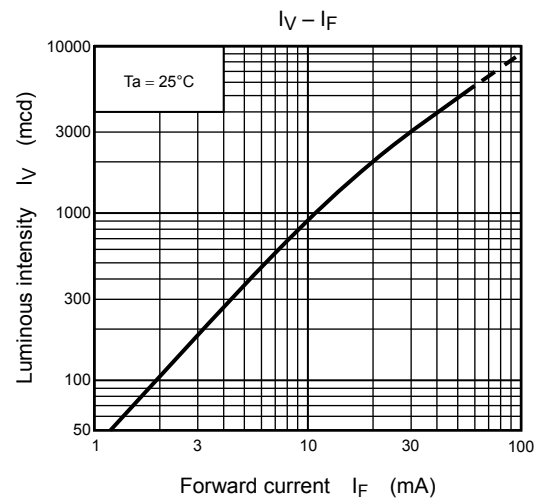
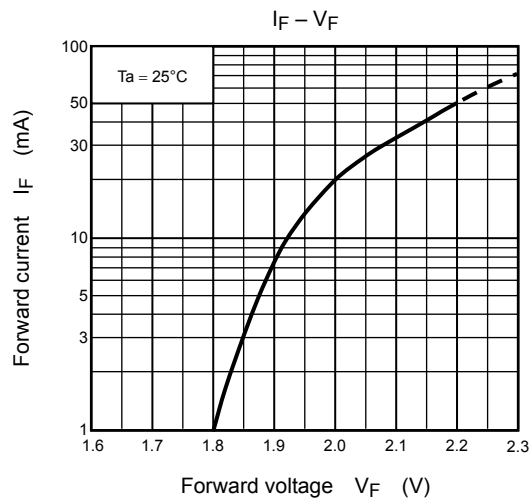


Radiation pattern

Ta = 25°C

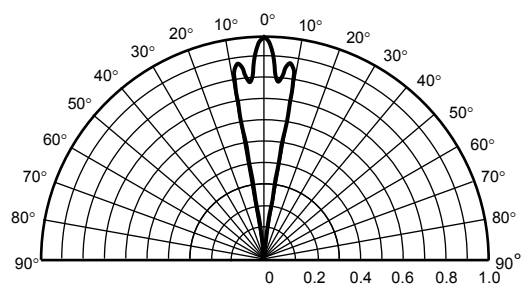


TLPYE19TP(F)



Radiation pattern

Ta = 25°C



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